

Superior Efficacy and Lumen output with Small Form Factor

Z Power LED - Z5-M1

SZ5-M1-WX-XX (Cool, Neutral, Warm)











Product Brief

Description

- The Z-Power series is designed for high flux output applications with high current operation capability.
- It incorporates state of the art SMD design and low thermal resistant material.
- The Z Power LED is ideal light sources for directional lighting applications such as Spot Lights, various outdoor applications, automotive lightings and high performance torches.

Features and Benefits

- High Lumen Output and Efficacy
- Designed for high current operation
- Low Thermal Resistance
- Wide CCT range 3000~7000K
- High Color Quality, CRI Min. 80
- ANSI compliant Binning
- MacAdam 3 Step for Warm White

Key Applications

- Indoor lighting
- Outdoor lighting
- Automotive
- Architectural lighting
- Industrial lighting (High/Low bay)
- Portable Torch
- Home appliance

Table 1. Product Selection Table

Part Number		ССТ			CRI
Part Number	Color	Min.	Тур.	Max.	Min
SZ5-M1-W0-00	Cool White	4700K	5300K	7000K	70
SZ5-M1-WN-00	Neutral White	3700K	4000K	4700K	70
SZ5-M1-WN-C8	Neutral White	3700K	4000K	4700K	80
SZ5-M1-WW-C8	Warm White	2600K	3000K	3700K	80

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Company Information

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Performance Characteristics

Table 4-1. Electro Optical Characteristics, T_j = 25°C, RH30%

Part Number	CCT (K)	Typical Luminous Flux ^[2] Φ _V ^[3] (lm)		Typical Forward Voltage (V _t) ^[4]			CRI ^[5] , R _a	Viewing Angle (degrees) 20 ½	
	Тур.	350mA	700mA*	1.2A*	350mA	700mA*	1.2A*	Min.	Тур.
SZ5-M1-W0-00	5300	155	282	429	2.95	3.14	3.33	70	118
SZ5-M1-WN-00	4000	150	273	415	2.95	3.14	3.33	70	118
SZ5-M1-WN-C8	4000	138	250	382	2.95	3.14	3.33	80	118
SZ5-M1-WW-C8	3000	128	231	353	2.95	3.14	3.33	80	118

Table 4-2. Electro Optical Characteristics, $T_j = 85^{\circ}C$

Part Number	CCT (K)	Typical Luminous Flux ^[2] Φ _v ^[3] (lm)			_	vpical Forward Voltage (V _f) ^[4]	d
	Тур.	350mA	700mA*	1.2A*	350mA	700mA*	1.2A*
SZ5-M1-W0-00	5300	142	258	393	2.78	2.96	3.14
SZ5-M1-WN-00	4000	137	250	380	2.78	2.96	3.14
SZ5-M1-WN-C8	4000	126	229	349	2.78	2.96	3.14
SZ5-M1-WW-C8	3000	117	210	322	2.78	2.96	3.14

Notes:

- (1) Correlated Color Temperature is derived from the CIE 1931 Chromaticity diagram. Color coordinate: ±0.005, CCT ±5% tolerance.
- (2) Seoul Semiconductor maintains a tolerance of $\pm 7\%$ on flux and power measurements.
- (3) Φ_V is the total luminous flux output as measured with an integrating sphere.
- (4) Tolerance is ± 0.06 V on forward voltage measurements.
- (5) Tolerance is ± 2.0 on CRI measurements.

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^{*} Calculated performance values are for reference only.



Performance Characteristics

Table 5. Absolute Maximum Ratings, T_j = 25°C

Parameter	Symbol	Value			Unit
Falanietei	Symbol	Min.	Тур.	Max.	Offic
Forward Current [1]	I _F	-	-	1.5	Α
Peak Pulsed Forward Current [2]	I _F			2.0	Α
Reverse Voltage	V_{r}	-	-	5	V
Power Dissipation	P_d	-	-	5.22	W
Junction Temperature	T _j	-	-	150	°C
Operating Temperature	T_{opr}	- 40	-	125	°C
Storage Temperature	T _{stg}	- 40	-	125	°C
Thermal resistance (J to S) [3]	Rθ _{J-S}	-	4.5	-	K/W
ESD Sensitivity(HBM) [4]		Class	3A JESD22-A	114-E	

Notes:

- (2) Pulse width ≤10ms, duty cycle ≤ 10% condition.
- (3) $R\theta_{J-S}$ is tested at 350mA.
- (4) The zener diode is included to protect the product from ESD.



Relative Spectral Distribution

Fig 1. Color Spectrum ($T_i = 25^{\circ}C$)

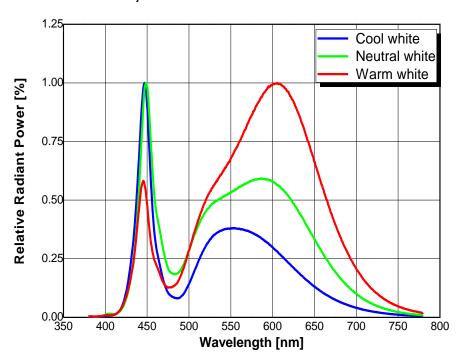
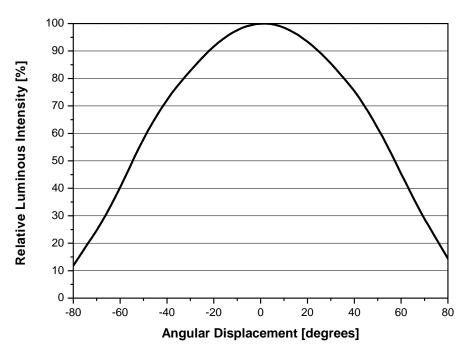


Fig 2. Typical Spatial Distribution





Forward Current Characteristics

Fig 3. Forward Voltage vs. Forward Current ($T_j = 25 \, ^{\circ}{\rm C}$)

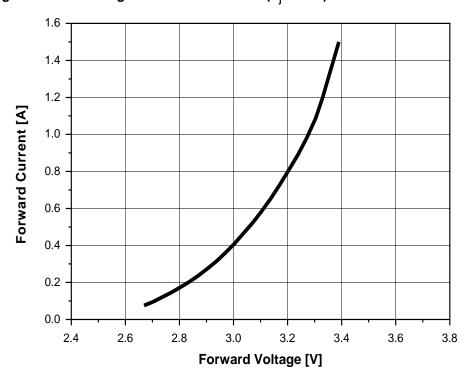
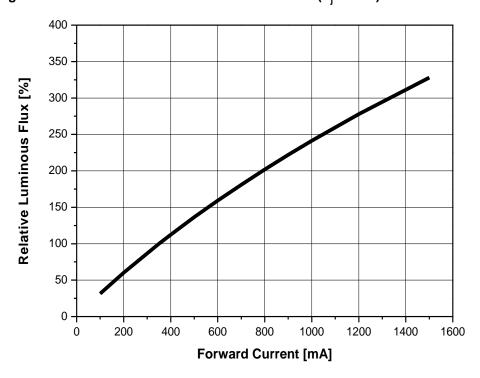


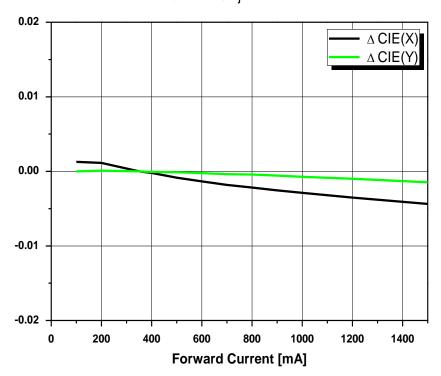
Fig 4. Forward Current vs. Relative Luminous Flux ($T_i = 25^{\circ}$ C)



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Forward Current Characteristics

Fig 5. Forward Current vs. CIE X, Y Shift, T_j = 25 $^{\circ}$ C





Junction Temperature Characteristics

Fig 6. Relative Light Output vs. Junction Temperature, $I_F = 350 \text{mA}$

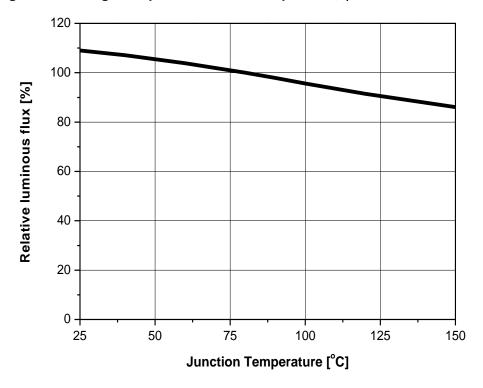
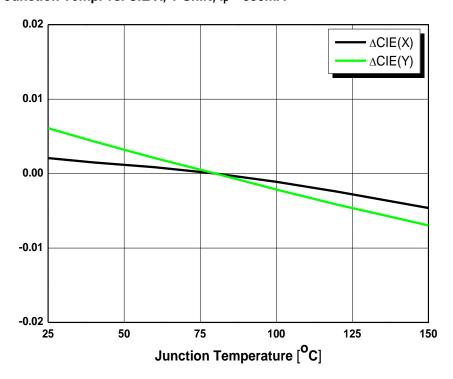
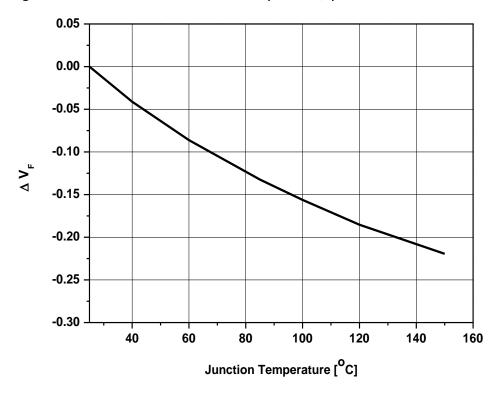


Fig 7. Junction Temp. vs. CIE X, Y Shift, $I_F = 350 \text{mA}$



Junction Temperature Characteristics

Fig 8. Relative Forward vs. Junction Temperature, $I_F = 350 \text{mA}$



Ambient Temperature Characteristics

Fig 9. Maximum Forward Current vs. Ambient Temperature, $T_i(max.) = 150 \, ^{\circ}\text{C}$, $I_F = 1.5 \, \text{A}$

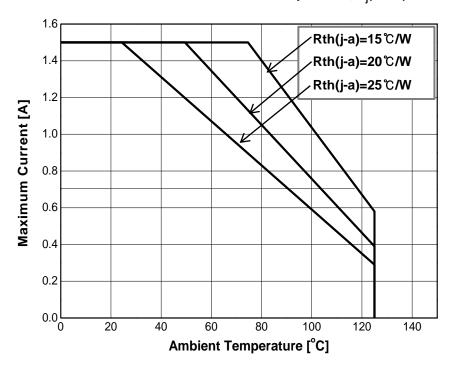
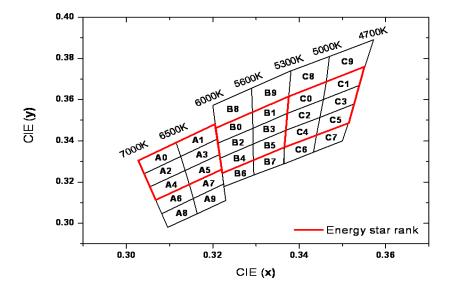




Table 6. Bin Code description

Part Number		nous Flux (I I _F = 350mA	m)	Color Chromaticity Coordinate	Typical Forward Voltage (V _f)		
	Bin Code	Min.	Max.			Min.	Max.
	V2	130	140		G	2.75	3.00
SZ5-M1-W0-00	V3	140	150	Refer to page.12	Н	3.00	3.25
323-1011-000	W1	150	160	Kelel to page. 12		3.00	3.23
	W2	160	170		I	3.25	3.50
	V2	130	140		G	2.75	3.00
SZ5-M1-WN-00	V3 140 150	Refer to page 13	Н	3.00	3.25		
323-1011-0010-00	W1	150	160	Refer to page.13		5.00	3.23
	W2	160	170		I	3.25	3.50
	U3	109	118.5		G	2.75	3.00
SZ5-M1-WN-C8	V1	118.5	130	Refer to page.13	Н	3.00	3.25
325-1011-0010-00	V2	130	140	Neier to page. 13		3.00	3.23
	V3	140	150		I	3.25	3.50
	U3	109	118.5		G	2.75	3.00
SZ5-M1-WW-C8	V1	118.5	130	Refer to page.14	Н	3.00	3.25
023 W1-WW-00	V2	130	140	Note: to page. 14		5.00	0.20
	V3 140 150		I	3.25	3.50		

CIE Chromaticity Diagram (Cool white), $T_j = 25 \, ^{\circ} \! \text{C}$, $I_F = 350 \text{mA}$

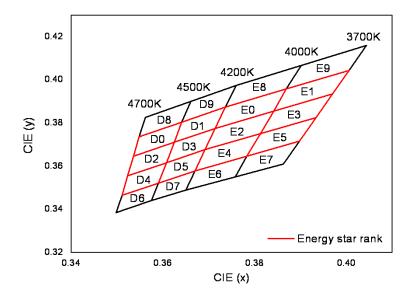


Α	70	A	.1	A	.2	A	.3	A	4
CIE x	CIE y	CIE x	CIE y	CIE x	CIE y	CIE x	CIE y	CIE x	CIE y
0.3028	0.3304	0.3115	0.3393	0.3041	0.3240	0.3126	0.3324	0.3055	0.3177
0.3041	0.3240	0.3126	0.3324	0.3055	0.3177	0.3136	0.3256	0.3068	0.3113
0.3126	0.3324	0.3210	0.3408	0.3136	0.3256	0.3216	0.3334	0.3146	0.3187
0.3115	0.3393	0.3205	0.3481	0.3126	0.3324	0.3210	0.3408	0.3136	0.3256
Α	5	A	6	Α	7	A	8	А	9
CIE x	CIE y	CIE x	CIE y	CIE x	CIE y	CIE x	CIE y	CIE x	CIE y
0.3136	0.3256	0.3068	0.3113	0.3146	0.3187	0.3082	0.3046	0.3155	0.3120
0.3146	0.3187	0.3082	0.3046	0.3155	0.3120	0.3096	0.2980	0.3164	0.3046
0.3221	0.3261	0.3155	0.3120	0.3225	0.3190	0.3164	0.3046	0.3230	0.3110
0.3216	0.3334	0.3146	0.3187	0.3221	0.3261	0.3155	0.3120	0.3225	0.3190
_	30	_	1		2	_	3	_	4
CIE x	CIE y	CIE x	CIE y	CIE x	CIE y	CIE x	CIE y	CIE x	CIE y
0.3207	0.3462	0.3292	0.3539	0.3212	0.3389	0.3293	0.3461	0.3217	0.3316
0.3212	0.3389	0.3293	0.3461	0.3217	0.3316	0.3293	0.3384	0.3222	0.3243
0.3293	0.3461	0.3373	0.3534	0.3293	0.3384	0.3369	0.3451	0.3294	0.3306
0.3292	0.3539	0.3376	0.3616	0.3293	0.3461	0.3373	0.3534	0.3293	0.3384
	5		6		7		8	В	
CIE x	CIE y	CIE x	CIE y	CIE x	CIE y	CIE x	CIE y	CIE x	CIE y
CIE x 0.3293	CIE y 0.3384	CIE x 0.3222	CIE y 0.3243	CIE x 0.3294	CIE y 0.3306	CIE x 0.3200	CIE y 0.3572	CIE x 0.3290	CIE y 0.3656
CIE x 0.3293 0.3294	CIE y 0.3384 0.3306	CIE x 0.3222 0.3226	CIE y 0.3243 0.3178	CIE x 0.3294 0.3295	CIE y 0.3306 0.3234	CIE x 0.3200 0.3207	CIE y 0.3572 0.3462	CIE x 0.3290 0.3292	CIE y 0.3656 0.3539
CIE x 0.3293 0.3294 0.3366	CIE y 0.3384 0.3306 0.3369	CIE x 0.3222 0.3226 0.3295	CIE y 0.3243 0.3178 0.3234	CIE x 0.3294 0.3295 0.3364	CIE y 0.3306 0.3234 0.3288	CIE x 0.3200 0.3207 0.3292	CIE y 0.3572 0.3462 0.3539	CIE x 0.3290 0.3292 0.3376	CIE y 0.3656 0.3539 0.3616
CIE x 0.3293 0.3294 0.3366 0.3369	CIE y 0.3384 0.3306 0.3369 0.3451	CIE x 0.3222 0.3226 0.3295 0.3294	CIE y 0.3243 0.3178 0.3234 0.3306	CIE x 0.3294 0.3295 0.3364 0.3366	CIE y 0.3306 0.3234 0.3288 0.3369	CIE x 0.3200 0.3207 0.3292 0.3290	CIE y 0.3572 0.3462 0.3539 0.3656	CIE x 0.3290 0.3292 0.3376 0.3381	CIE y 0.3656 0.3539 0.3616 0.3740
CIE x 0.3293 0.3294 0.3366 0.3369	CIE y 0.3384 0.3306 0.3369 0.3451	CIE x 0.3222 0.3226 0.3295 0.3294	CIE y 0.3243 0.3178 0.3234 0.3306	CIE x 0.3294 0.3295 0.3364 0.3366	CIE y 0.3306 0.3234 0.3288 0.3369	CIE x 0.3200 0.3207 0.3292 0.3290	CIE y 0.3572 0.3462 0.3539 0.3656	CIE x 0.3290 0.3292 0.3376 0.3381	CIE y 0.3656 0.3539 0.3616 0.3740
CIE x 0.3293 0.3294 0.3366 0.3369	CIE y 0.3384 0.3306 0.3369 0.3451	CIE x 0.3222 0.3226 0.3295 0.3294	CIE y 0.3243 0.3178 0.3234 0.3306	CIE x 0.3294 0.3295 0.3364 0.3366	CIE y 0.3306 0.3234 0.3288 0.3369	CIE x 0.3200 0.3207 0.3292 0.3290	CIE y 0.3572 0.3462 0.3539 0.3656	CIE x 0.3290 0.3292 0.3376 0.3381	CIE y 0.3656 0.3539 0.3616 0.3740
CIE x 0.3293 0.3294 0.3366 0.3369 CIE x 0.3376	CIE y 0.3384 0.3306 0.3369 0.3451 CIE y 0.3616	CIE x 0.3222 0.3226 0.3295 0.3294 CIE x 0.3463	CIE y 0.3243 0.3178 0.3234 0.3306 CIE y 0.3687	CIE x 0.3294 0.3295 0.3364 0.3366 CIE x 0.3373	CIE y 0.3306 0.3234 0.3288 0.3369 2 CIE y 0.3534	CIE x 0.3200 0.3207 0.3292 0.3290 CIE x 0.3456	CIE y 0.3572 0.3462 0.3539 0.3656 3 CIE y 0.3601	CIE x 0.3290 0.3292 0.3376 0.3381 CIE x 0.3369	CIE y 0.3656 0.3539 0.3616 0.3740 4 CIE y 0.3451
CIE x 0.3293 0.3294 0.3366 0.3369 CIE x 0.3376 0.3373	CIE y 0.3384 0.3306 0.3369 0.3451 0 CIE y 0.3616 0.3534	CIE x 0.3222 0.3226 0.3295 0.3294 CIE x 0.3463 0.3456	CIE y 0.3243 0.3178 0.3234 0.3306 1 CIE y 0.3687 0.3601	CIE x 0.3294 0.3295 0.3364 0.3366 CIE x 0.3373 0.3369	CIE y 0.3306 0.3234 0.3288 0.3369 2 CIE y 0.3534 0.3451	CIE x 0.3200 0.3207 0.3292 0.3290 CIE x 0.3456 0.3448	CIE y 0.3572 0.3462 0.3539 0.3656 3 CIE y 0.3601 0.3514	CIE x 0.3290 0.3292 0.3376 0.3381 CIE x 0.3369 0.3366	CIE y 0.3656 0.3539 0.3616 0.3740 4 CIE y 0.3451 0.3369
CIE x 0.3293 0.3294 0.3366 0.3369 CIE x 0.3376 0.3373 0.3456	CIE y 0.3384 0.3306 0.3369 0.3451 0 CIE y 0.3616 0.3534 0.3601	CIE x 0.3222 0.3226 0.3295 0.3294 CIE x 0.3463 0.3456 0.3539	CIE y 0.3243 0.3178 0.3234 0.3306 1 CIE y 0.3687 0.3601 0.3669	CIE x 0.3294 0.3295 0.3364 0.3366 CIE x 0.3373 0.3369 0.3448	CIE y 0.3306 0.3234 0.3288 0.3369 2 CIE y 0.3534 0.3451 0.3514	CIE x 0.3200 0.3207 0.3292 0.3290 CIE x 0.3456 0.3448 0.3526	CIE y 0.3572 0.3462 0.3539 0.3656 3 CIE y 0.3601 0.3514 0.3578	CIE x 0.3290 0.3292 0.3376 0.3381 CIE x 0.3369 0.3366 0.3440	CIE y 0.3656 0.3539 0.3616 0.3740 4 CIE y 0.3451 0.3369 0.3428
CIE x 0.3293 0.3294 0.3366 0.3369 CIE x 0.3376 0.3373 0.3456 0.3463	CIE y 0.3384 0.3306 0.3369 0.3451 60 CIE y 0.3616 0.3534 0.3601 0.3687	CIE x 0.3222 0.3226 0.3295 0.3294 CIE x 0.3463 0.3456 0.3539 0.3552	CIE y 0.3243 0.3178 0.3234 0.3306 21 CIE y 0.3687 0.3601 0.3669 0.3760	CIE x 0.3294 0.3295 0.3364 0.3366 CIE x 0.3373 0.3369 0.3448 0.3456	CIE y 0.3306 0.3234 0.3288 0.3369 2 CIE y 0.3534 0.3451 0.3514 0.3601	CIE x 0.3200 0.3207 0.3292 0.3290 CIE x 0.3456 0.3448 0.3526 0.3539	CIE y 0.3572 0.3462 0.3539 0.3656 3 CIE y 0.3601 0.3514 0.3578 0.3669	CIE x 0.3290 0.3292 0.3376 0.3381 CIE x 0.3369 0.3366 0.3440 0.3448	CIE y 0.3656 0.3539 0.3616 0.3740 64 CIE y 0.3451 0.3369 0.3428 0.3514
CIE x 0.3293 0.3294 0.3366 0.3369 CIE x 0.3376 0.3456 0.3463	CIE y 0.3384 0.3306 0.3369 0.3451 0 CIE y 0.3616 0.3534 0.3601 0.3687	CIE x 0.3222 0.3226 0.3295 0.3294 CIE x 0.3463 0.3456 0.3539 0.3552	CIE y 0.3243 0.3178 0.3234 0.3306 31 CIE y 0.3687 0.3601 0.3669 0.3760	CIE x 0.3294 0.3295 0.3364 0.3366 CIE x 0.3373 0.3369 0.3448 0.3456	CIE y 0.3306 0.3234 0.3288 0.3369 2 CIE y 0.3534 0.3451 0.3514 0.3601	CIE x 0.3200 0.3207 0.3292 0.3290 CIE x 0.3456 0.3448 0.3526 0.3539	CIE y 0.3572 0.3462 0.3539 0.3656 3 CIE y 0.3601 0.3514 0.3578 0.3669	CIE x 0.3290 0.3292 0.3376 0.3381 CIE x 0.3369 0.3366 0.3440 0.3448	CIE y 0.3656 0.3539 0.3616 0.3740 4 CIE y 0.3451 0.3369 0.3428 0.3514
CIE x 0.3293 0.3294 0.3366 0.3369 CIE x 0.3376 0.3456 0.3463	CIE y 0.3384 0.3306 0.3369 0.3451 60 CIE y 0.3616 0.3534 0.3601 0.3687	CIE x 0.3222 0.3226 0.3295 0.3294 CIE x 0.3463 0.3456 0.3539 0.3552 CIE x	CIE y 0.3243 0.3178 0.3234 0.3306 CIE y 0.3687 0.3601 0.3669 0.3760 CIE y	CIE x 0.3294 0.3295 0.3364 0.3366 CIE x 0.3373 0.3369 0.3448 0.3456	CIE y 0.3306 0.3234 0.3288 0.3369 2 CIE y 0.3534 0.3451 0.3514 0.3601 7 CIE y	CIE x 0.3200 0.3207 0.3292 0.3290 CIE x 0.3456 0.3448 0.3526 0.3539 CIE x	CIE y 0.3572 0.3462 0.3539 0.3656 3 CIE y 0.3601 0.3514 0.3578 0.3669 8 CIE y	CIE x 0.3290 0.3292 0.3376 0.3381 CIE x 0.3369 0.3366 0.3440 0.3448	CIE y 0.3656 0.3539 0.3616 0.3740 4 CIE y 0.3451 0.3369 0.3428 0.3514
CIE x 0.3293 0.3294 0.3366 0.3369 CIE x 0.3376 0.3456 0.3463 CIE x 0.3448	CIE y 0.3384 0.3306 0.3369 0.3451 60 CIE y 0.3616 0.3534 0.3601 0.3687 55 CIE y 0.3514	CIE x 0.3222 0.3226 0.3295 0.3294 CIE x 0.3463 0.3456 0.3539 0.3552 CIE x 0.3366	CIE y 0.3243 0.3178 0.3234 0.3306 CIE y 0.3687 0.3601 0.3669 0.3760 CIE y 0.3369	CIE x 0.3294 0.3295 0.3364 0.3366 CIE x 0.3373 0.3369 0.3448 0.3456	CIE y 0.3306 0.3234 0.3288 0.3369 2 CIE y 0.3534 0.3451 0.3514 0.3601 7 CIE y 0.3428	CIE x 0.3200 0.3207 0.3292 0.3290 CIE x 0.3456 0.3448 0.3526 0.3539 CIE x 0.3381	CIE y 0.3572 0.3462 0.3539 0.3656 3 CIE y 0.3601 0.3514 0.3578 0.3669 8 CIE y 0.3740	CIE x 0.3290 0.3292 0.3376 0.3381 CIE x 0.3369 0.3366 0.3440 0.3448	CIE y 0.3656 0.3539 0.3616 0.3740 4 CIE y 0.3451 0.3369 0.3428 0.3514
CIE x 0.3293 0.3294 0.3366 0.3369 CIE x 0.3376 0.3456 0.3463 CIE x 0.3448 0.3440	CIE y 0.3384 0.3306 0.3369 0.3451 0 CIE y 0.3616 0.3534 0.3601 0.3687 5 CIE y 0.3514 0.3428	CIE x 0.3222 0.3226 0.3295 0.3294 CIE x 0.3463 0.3456 0.3539 0.3552 CIE x 0.3366 0.3364	CIE y 0.3243 0.3178 0.3234 0.3306 CIE y 0.3687 0.3601 0.3669 0.3760 CIE y 0.3369 0.3369 0.3288	CIE x 0.3294 0.3295 0.3364 0.3366 CIE x 0.3373 0.3369 0.3448 0.3456 CIE x 0.3440 0.3433	CIE y 0.3306 0.3234 0.3288 0.3369 2 CIE y 0.3534 0.3451 0.3514 0.3601 7 CIE y 0.3428 0.3345	CIE x 0.3200 0.3207 0.3292 0.3290 CIE x 0.3456 0.3448 0.3526 0.3539 CIE x 0.3381 0.3376	CIE y 0.3572 0.3462 0.3539 0.3656 3 CIE y 0.3601 0.3514 0.3578 0.3669 8 CIE y 0.3740 0.3616	CIE x 0.3290 0.3292 0.3376 0.3381 CIE x 0.3369 0.3366 0.3440 0.3448 CIE x 0.3470 0.3463	CIE y 0.3656 0.3539 0.3616 0.3740 4 CIE y 0.3451 0.3369 0.3428 0.3514 9 CIE y 0.3810 0.3687
CIE x 0.3293 0.3294 0.3366 0.3369 CIE x 0.3376 0.3456 0.3463 CIE x 0.3448	CIE y 0.3384 0.3306 0.3369 0.3451 60 CIE y 0.3616 0.3534 0.3601 0.3687 55 CIE y 0.3514	CIE x 0.3222 0.3226 0.3295 0.3294 CIE x 0.3463 0.3456 0.3539 0.3552 CIE x 0.3366	CIE y 0.3243 0.3178 0.3234 0.3306 CIE y 0.3687 0.3601 0.3669 0.3760 CIE y 0.3369	CIE x 0.3294 0.3295 0.3364 0.3366 CIE x 0.3373 0.3369 0.3448 0.3456	CIE y 0.3306 0.3234 0.3288 0.3369 2 CIE y 0.3534 0.3451 0.3514 0.3601 7 CIE y 0.3428	CIE x 0.3200 0.3207 0.3292 0.3290 CIE x 0.3456 0.3448 0.3526 0.3539 CIE x 0.3381	CIE y 0.3572 0.3462 0.3539 0.3656 3 CIE y 0.3601 0.3514 0.3578 0.3669 8 CIE y 0.3740	CIE x 0.3290 0.3292 0.3376 0.3381 CIE x 0.3369 0.3366 0.3440 0.3448	CIE y 0.3656 0.3539 0.3616 0.3740 4 CIE y 0.3451 0.3369 0.3428 0.3514

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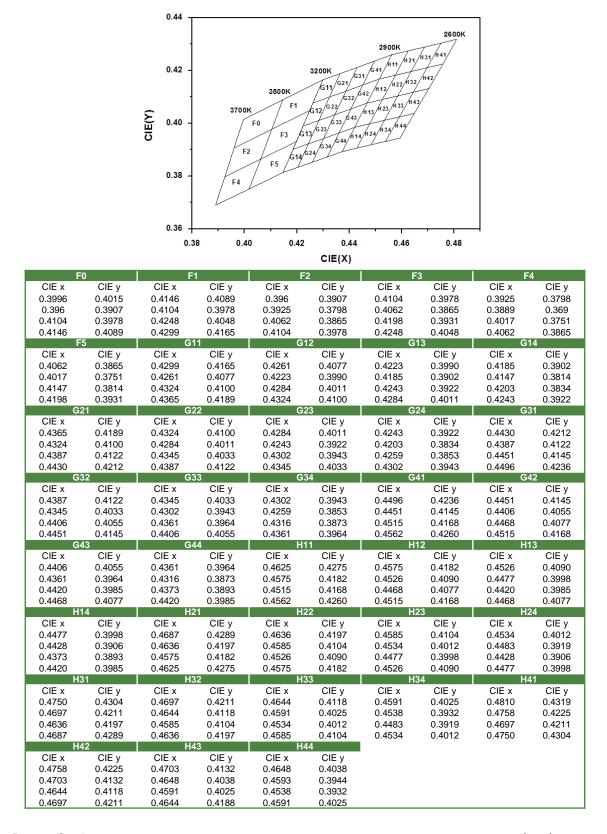
CIE Chromaticity Diagram (Neutral white), $T_j = 25 \, ^{\circ} \! \text{C}$, $I_F = 350 \text{mA}$



D	0	D	1	D	2	D	3	D)4
CIE x	CIE y	CIE x	CIE y	CIE x	CIE y	CIE x	CIE y	CIE x	CIE y
0.3548	0.3736	0.3641	0.3804	0.3536	0.3646	0.3625	0.3711	0.3524	0.3555
0.3536	0.3646	0.3625	0.3711	0.3524	0.3555	0.3608	0.3616	0.3512	0.3465
0.3625	0.3711	0.3714	0.3775	0.3608	0.3616	0.3692	0.3677	0.3590	0.3521
0.3641	0.3804	0.3736	0.3874	0.3625	0.3711	0.3714	0.3775	0.3608	0.3616
D	5	D	6	D	7	D		D	9
CIE x	CIE y	CIE x	CIE y	CIE x	CIE y	CIE x	CIE y	CIE x	CIE y
0.3608	0.3616	0.3512	0.3465	0.3590	0.3521	0.3562	0.3826	0.3661	0.3900
0.3590	0.3521	0.3497	0.3385	0.3575	0.3441	0.3548	0.3736	0.3641	0.3804
0.3670	0.3578	0.3575	0.3441	0.3650	0.3489	0.3641	0.3804	0.3736	0.3874
0.3692	0.3677	0.3590	0.3521	0.3670	0.3578	0.3661	0.3900	0.3760	0.3974
E	0	E	1	E	2	E	3	E	4
CIE x	CIE y	CIE x	CIE y	CIE x	CIE y	CIE x	CIE y	CIE x	CIE y
CIE x 0.3736	CIE y 0.3874	CIE x 0.3869	CIE y 0.3958	CIE x 0.3714	CIE y 0.3775	CIE x 0.3842	CIE y 0.3855	CIE x 0.3692	CIE y 0.3677
			-		-		-		-
0.3736	0.3874	0.3869	0.3958	0.3714	0.3775	0.3842	0.3855	0.3692	0.3677
0.3736 0.3714	0.3874 0.3775	0.3869 0.3842	0.3958 0.3855	0.3714 0.3692	0.3775 0.3677	0.3842 0.3813	0.3855 0.3751	0.3692 0.3670	0.3677 0.3578
0.3736 0.3714 0.3842	0.3874 0.3775 0.3855 0.3958	0.3869 0.3842 0.3970 0.4006	0.3958 0.3855 0.3935	0.3714 0.3692 0.3813 0.3842	0.3775 0.3677 0.3751	0.3842 0.3813 0.3934 0.3970	0.3855 0.3751 0.3825	0.3692 0.3670 0.3783 0.3813	0.3677 0.3578 0.3646
0.3736 0.3714 0.3842 0.3869	0.3874 0.3775 0.3855 0.3958	0.3869 0.3842 0.3970 0.4006	0.3958 0.3855 0.3935 0.4044	0.3714 0.3692 0.3813 0.3842	0.3775 0.3677 0.3751 0.3855	0.3842 0.3813 0.3934 0.3970	0.3855 0.3751 0.3825 0.3935	0.3692 0.3670 0.3783 0.3813	0.3677 0.3578 0.3646 0.3751
0.3736 0.3714 0.3842 0.3869	0.3874 0.3775 0.3855 0.3958	0.3869 0.3842 0.3970 0.4006	0.3958 0.3855 0.3935 0.4044	0.3714 0.3692 0.3813 0.3842	0.3775 0.3677 0.3751 0.3855	0.3842 0.3813 0.3934 0.3970	0.3855 0.3751 0.3825 0.3935	0.3692 0.3670 0.3783 0.3813	0.3677 0.3578 0.3646 0.3751
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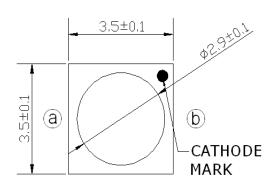
CIE Chromaticity Diagram (Warm white), T_i = 25 °C, I_F = 350mA

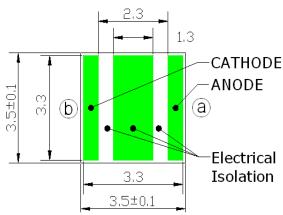


Mechanical Dimensions

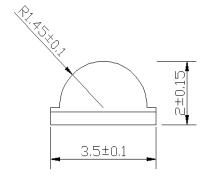
Top View

Bottom View

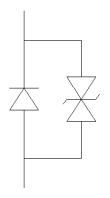




Side View



Circuit

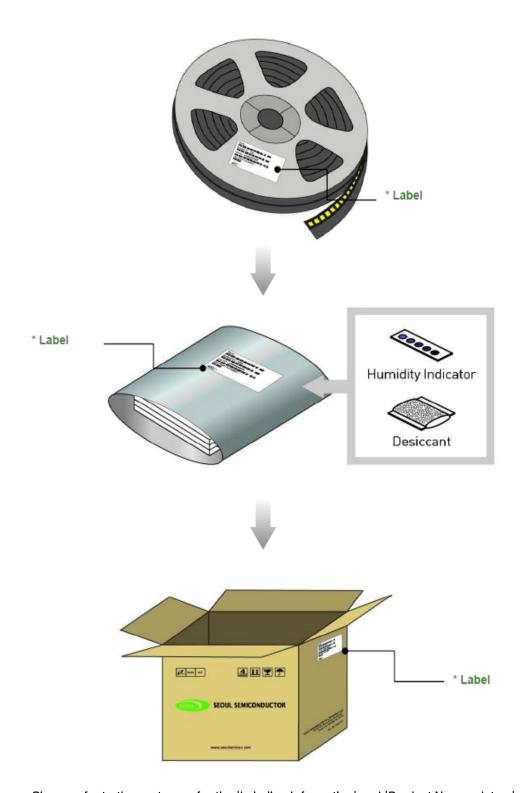


Notes:

- (1) All dimensions are in millimeters.
- (2) Scale: none
- (3) Undefined tolerance is ± 0.1 mm



Emitter Tape & Reel Packaging



* Please refer to the next page for the 'Labeling Information' and 'Product Nomenclature'.

Product Nomenclature

RANK:

QUANTITY: #####

LOT NUMBER: ###### #### ###

SSC PART NUMBER : ### ## ##

INTERNI DEN TERRETE I TERRETE BESTELLE BESTE FERSE FERSE FERSE

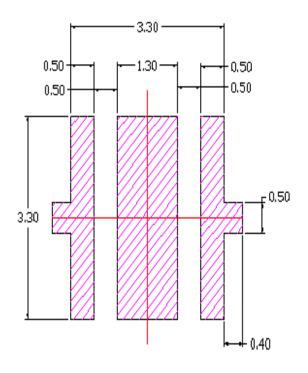


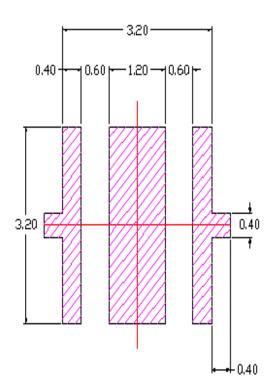
Table 2. Part Numbering System : $X_1X_2X_3 - X_4X_5 - X_6X_7 - X_8X_9$

Part Number Code	Description	Part Number	Value
X ₁	Company	S	
X ₂	Z-Power LED series number	Z	
X ₃	PKG series	5	
X ₄	PKG series	М	M series
X ₅	Revision number	1	New version
X ₆ X ₇	Color Specification	WO	Pure white
		WN	Neutral white
		WW	Warm white
X ₈ X ₉	Color Specification	C8	CRI (min.) 80
		C9	CRI (min.) 90
		00	The others

Lot Number Code	Description
Y ₁	Year
Y ₂	Month
Y ₃	Day
Y ₄	Production area
Y ₅	Mass order
Y ₆	Taping number
Y ₇	Reel number
Y ₈	Internal management number

Recommended Solder Pad





Recommended PCB Solder Pad

Recommended Stencil Pattern

Notes:

- (1) All dimensions are in millimeters.
- (2) Scale: none
- (3) This drawing without tolerances are for reference only.
- (4) Undefined tolerance is ± 0.1 mm.

Reflow Soldering Characteristics

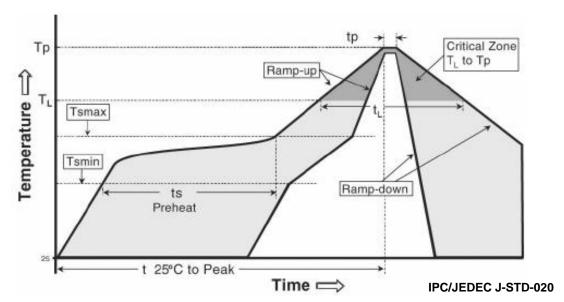


Table 5.

Profile Feature	Sn-Pb Eutectic Assembly	Pb-Free Assembly
Average ramp-up rate (Tsmax to Tp)	3° C/second max.	3° C/second max.
Preheat - Temperature Min (Tsmin) - Temperature Max (Tsmax) - Time (Tsmin to Tsmax) (ts)	100 °C 150 °C 60-120 seconds	150 °C 200 °C 60-180 seconds
Time maintained above: - Temperature (TL) - Time (tL)	183 °C 60-150 seconds	217 °C 60-150 seconds
Peak Temperature (Tp)	215℃	260℃
Time within 5°C of actual Peak Temperature (tp)2	10-30 seconds	20-40 seconds
Ramp-down Rate	6 °C/second max.	6 °C/second max.
Time 25°C to Peak Temperature	6 minutes max.	8 minutes max.

Caution

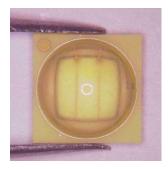
- (1) Reflow soldering is recommended not to be done more than two times. In the case of more than 24 hours passed soldering after first, LEDs will be damaged.
- (2) Repairs should not be done after the LEDs have been soldered. When repair is unavoidable, suitable tools must be used.
- (3) Die slug is to be soldered.
- (4) When soldering, do not put stress on the LEDs during heating.
- (5) After soldering, do not warp the circuit board.

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Handling of Silicone Resin for LEDs

(1) During processing, mechanical stress on the surface should be minimized as much as possible. Sharp objects of all types should not be used to pierce the sealing compound.





- (2) In general, LEDs should only be handled from the side. By the way, this also applies to LEDs without a silicone sealant, since the surface can also become scratched.
- (3) When populating boards in SMT production, there are basically no restrictions regarding the form of the pick and place nozzle, except that mechanical pressure on the surface of the resin must be prevented. This is assured by choosing a pick and place nozzle which is larger than the LED's reflector area.
- (4) Silicone differs from materials conventionally used for the manufacturing of LEDs. These conditions must be considered during the handling of such devices. Compared to standard encapsulants, silicone is generally softer, and the surface is more likely to attract dust. As mentioned previously, the increased sensitivity to dust requires special care during processing. In cases where a minimal level of dirt and dust particles cannot be guaranteed, a suitable cleaning solution must be applied to the surface after the soldering of components.
- (5) Seoul Semiconductor suggests using isopropyl alcohol for cleaning. In case other solvents are used, it must be assured that these solvents do not dissolve the package or resin. Ultrasonic cleaning is not recommended. Ultrasonic cleaning may cause damage to the LED.
- (6) Please do not mold this product into another resin (epoxy, urethane, etc) and do not handle this product with acid or sulfur material in sealed space.
- (7) Avoid leaving fingerprints on silicone resin parts.

Precaution for Use

(1) Storage

To avoid the moisture penetration, we recommend storing Z5 Series LEDs in a dry box with a desiccant . The recommended storage temperature range is $5\,^{\circ}$ C to $30\,^{\circ}$ C and a maximum humidity of RH50%.

- (2) Use Precaution after Opening the Packaging
 - Use proper SMD techniques when the LED is to be soldered dipped as separation of the lens may affect the light output efficiency. Pay attention to the following:
 - a. Recommend conditions after opening the package
 - Sealing / Temperature : 5 ~ 40 °C Humidity : less than RH30%
 - b. If the package has been opened more than 1 year (MSL 2) or the color of the desiccant changes, components should be dried for 10-12hr at 60 ± 5 °C
- (3) Do not apply mechanical force or excess vibration during the cooling process to normal temperature after soldering.
- (4) Do not rapidly cool device after soldering.
- (5) Components should not be mounted on warped (non coplanar) portion of PCB.
- (6) Radioactive exposure is not considered for the products listed here in.
- (7) Gallium arsenide is used in some of the products listed in this publication. These products are dangerous if they are burned or shredded in the process of disposal. It is also dangerous to drink the liquid or inhale the gas generated by such products when chemically disposed of.
- (8) This device should not be used in any type of fluid such as water, oil, organic solvent and etc. When washing is required, IPA (Isopropyl Alcohol) should be used.
- (9) When the LEDs are in operation the maximum current should be decided after measuring the package temperature.
- (10) LEDs must be stored properly to maintain the device. If the LEDs are stored for 3 months or more after being shipped from Seoul Semiconductor.
 - a sealed container with a nitrogen atmosphere should be used for storage.
- (11) The appearance and specifications of the product may be modified for improvement without notice.
- (12) Long time exposure of sunlight or occasional UV exposure will cause lens discoloration.
- (13) VOCs (Volatile organic compounds) emitted from materials used in the construction of fixtures can penetrate silicone encapsulants of LEDs and discolor when exposed to heat and photonic energy. The result can be a significant loss of light output from the fixture. Knowledge of the properties of the materials selected to be used in the construction of fixtures can help prevent these issues.
- (14) The slug is electrically isolated.
- (15) Attaching LEDs, do not use adhesives that outgas organic vapor.
- (16) The driving circuit must be designed to allow forward voltage only when it is ON or OFF.

 If the reverse voltage is applied to LED, migration can be generated resulting in LED damage.



Precaution for Use

(17) LEDs are sensitive to Electro-Static Discharge (ESD) and Electrical Over Stress (EOS).

Below is a list of suggestions that Seoul Semiconductor purposes to minimize these effects.

a. ESD (Electro Static Discharge)

Electrostatic discharge (ESD) is the defined as the release of static electricity when two objects come into contact. While most ESD events are considered harmless, it can be an expensive problem in many industrial environments during production and storage. The damage from ESD to an LEDs may cause the product to demonstrate unusual characteristics such as:

- Increase in reverse leakage current Lowered turn-on voltage
- Abnormal emissions from the LED at low current

The following Recommendations are suggested to help minimize the potential for an ESD event: One or more recommended work area suggestions:

- Ionizing fan setup
- ESD table/shelf mat made of conductive materials
- ESD safe storage containers

One or more personnel suggestion options:

- Antistatic Wrist-strap
- Antistatic material shoes
- Antistatic clothes

Environmental controls

- Humidity control (ESD gets worse in a dry environment)

b. EOS (Electrical Over Stress)

Electrical Over-Stress (EOS) is defined as damage that may occur when an electronic device is subjected to a current or voltage that is beyond the maximum specification limits of the device.

The effects from an EOS event can be noticed through product performance like:

Changes to the performance of the LED package (If the damage is around the bond pad area and since the package is completely encapsulated the package may turn on but flicker show severe performance degradation.)

Changes to the light output of the luminaire from component failure

Components on the board not operating at determined drive power

Failure of performance from entire fixture due to changes in circuit voltage and current across total circuit causing trickle down failures

It is impossible to predict the failure mode of every LED exposed to electrical overstress as the failure modes have been investigated to vary, but there are some common signs that will indicate an EOS event has occurred.

- Damaged may be noticed to the bond wires (appearing similar to a blown fuse)
- Damage to the bond pads located on the emission surface of the LED package (shadowing can be noticed around the bond pads while viewing through a microscope)
- Anomalies noticed in the encapsulation and phosphor around the bond wires.
- This damage usually appears due to the thermal stress produced during the EOS event.
- c. To help minimize the damage from an EOS event Seoul Semiconductor recommends utilizing
 - A surge protection circuit
 - An appropriately rated over voltage protection device
 - A current limiting device

Z5-M1 – High-Power LED

Company Information

Published by

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Company Information

Seoul Semiconductor (www.SeoulSemicon.com) manufacturers and packages a wide selection of light emitting diodes (LEDs) for the automotive, general illumination/lighting, Home appliance, signage and back lighting markets. The company is the world's fifth largest LED supplier, holding more than 10,000 patents globally, while offering a wide range of LED technology and production capacity in areas such as "nPola", "Acrich", the world's first commercially produced AC LED, and "Acrich MJT - Multi-Junction Technology" a proprietary family of high-voltage LEDs.

The company's broad product portfolio includes a wide array of package and device choices such as Acrich and Acirch2, high-brightness LEDs, mid-power LEDs, side-view LEDs, and through-hole type LEDs as well as custom modules, displays, and sensors.

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Z5-M1 – High-Power LED

Revision History

Revision	Date	Page	Remarks
1.0	01-08-2013	All	Initial release of data sheet applied